FAIRCHILD SEMICONDUCTOR®

October 2013

RURG8060_F085
80A, 600V Ultrafast Rectifier

Features

- High Speed Switching (t_{rr}=74ns(Typ.) @ I_F=80A)
- Low Forward Voltage(V_F=1.34V(Typ.) @ I_F=80A)
- Avalanche Energy Rated
- AEC-Q101 Qaulified

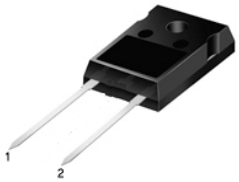
Applications

- Automotive DCDC converter
- Automotive On Board Charger
- Switching Power Supply
- Power Switching Circuits

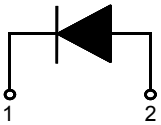
80A, 600V Ultrafast Rectifier

The RURG8060_F085 is an ultrafast diode with soft recovery characteristics (trr < 90ns). It has low forward voltage drop and is of silicon nitride passivated ion-implanted epitaxial planar construction.
This device is intended for use as a freewheeling/ clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and ultrafast recovery with soft recovery characteristic minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

Pin Assignments



TO-247-2L
1. Cathode 2. Anode



1. Cathode 2. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V_{RWM}	Working Peak Reverse Voltage	600	V
V_R	DC Blocking Voltage	600	V
$I_{F(AV)}$	Average Rectified Forward Current @ T_C = 25°C	80	A
I_{FSM}	Non-repetitive Peak Surge Current (Halfwave 1 Phase 50Hz)	240	A
E_{AVL}	Avalanche Energy (1.6A, 40mH)	50	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature	- 55 to +175	°C

Thermal Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	0.85	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	50	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Tube	Quantity
RURG8060	RURG8060_F085	TO-247	-	30

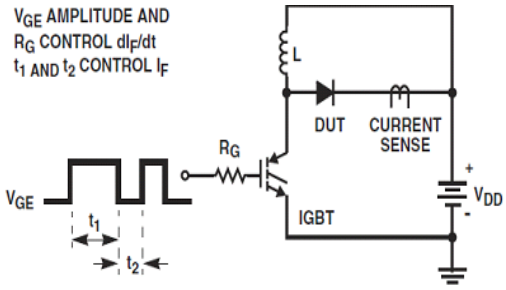
Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Conditions		Min.	Typ.	Max	Units
I_R	Instantaneous Reverse Current	V_R = 600V	T_C = 25 °C	-	-	250	uA
			T_C = 175 °C	-	-	2	mA
V_{FM}[1]	Instantaneous Forward Voltage	I_F = 80A	T_C = 25 °C T_C = 175 °C	- -	1.34 1.17	1.6 1.4	V V
t_{rr}[2]	Reverse Recovery Time	I_F =1A, di/dt = 100A/μs, V_{CC}= 390V	T_C = 25 °C	-	46	75	ns
		I_F =80A, di/dt = 100A/μs, V_{CC}= 390V	T_C = 25 °C T_C = 175 °C	- -	74 290	90	ns ns
t_a t_b Q_{rr}	Reverse Recovery Time Reverse Recovery Charge	I_F =80A, di/dt = 100A/μs, V_{CC}= 390V	T_C = 25 °C	- - -	38 36 130	- - -	ns ns nC
E_{AVL}	Avalanche Energy	I_{AV}=1.6A, L=40mH		50	-	-	mJ

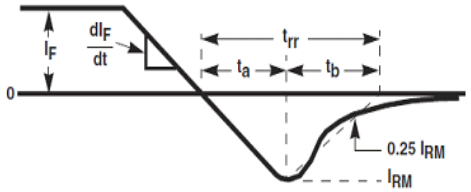
Notes:

1. Pulse : Test Pulse width = 300μs, Duty Cycle = 2%
2. Guaranteed by design

Test Circuit and Waveforms

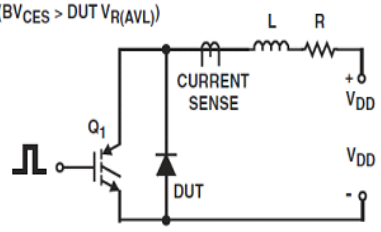


t_{rr} TEST CIRCUIT

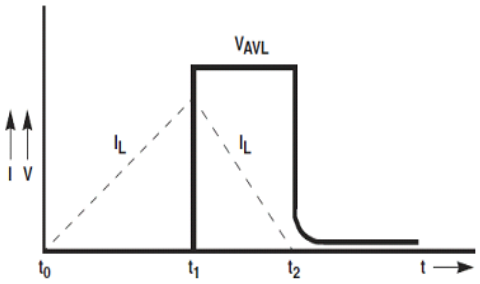


t_{rr} WAVEFORMS AND DEFINITIONS

I = 1.6A
L = 40mH
R < 0.1Ω
$E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$
Q_1 = IGBT (BV_{CES} > DUT $V_{R(AVL)}$)



AVALANCHE ENERGY TEST CIRCUIT



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop vs. Forward Current

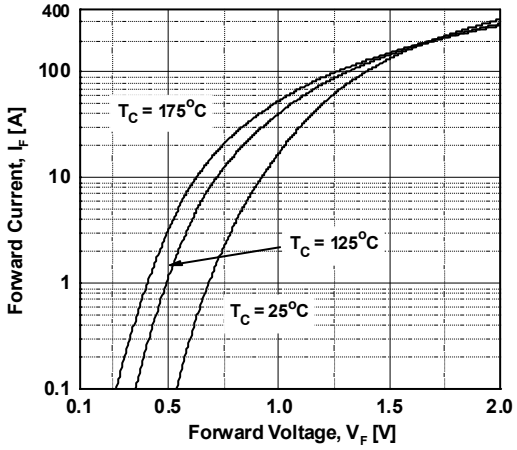


Figure 2. Typical Reverse Current vs. Reverse Voltage

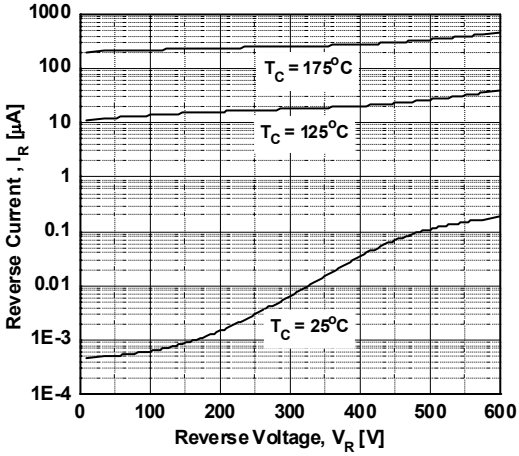


Figure 3.Typical Junction Capacitance

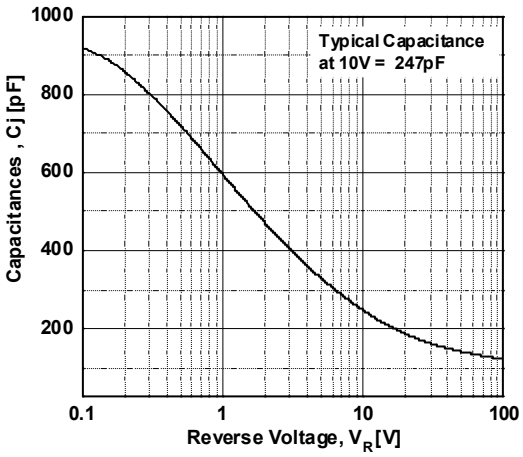


Figure 4. Typical Reverse Recovery Time vs. di/dt

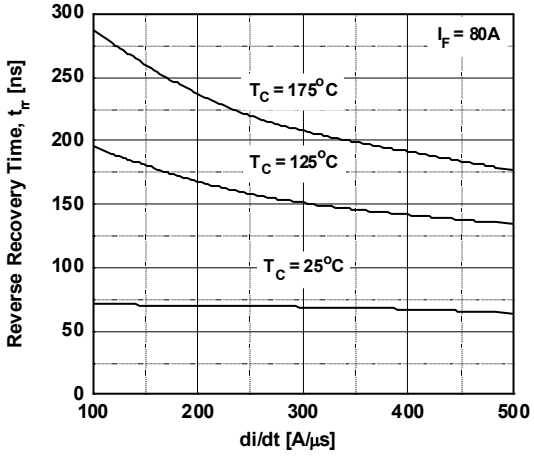


Figure 5. Typical Reverse Recovery Current vs. di/dt

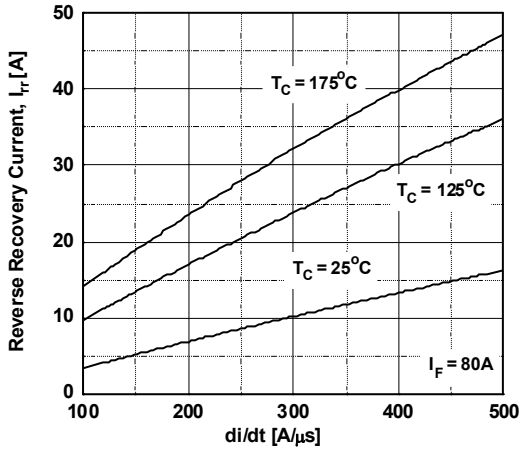
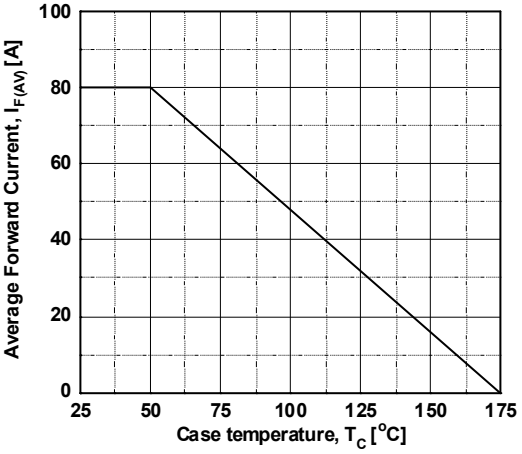


Figure 6. Forward Current Derating Curve



Typical Performance Characteristics (Continued)

Figure 7. Reverse Recovery Charge

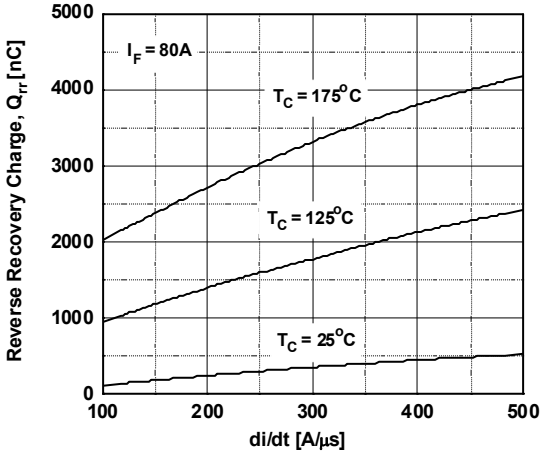
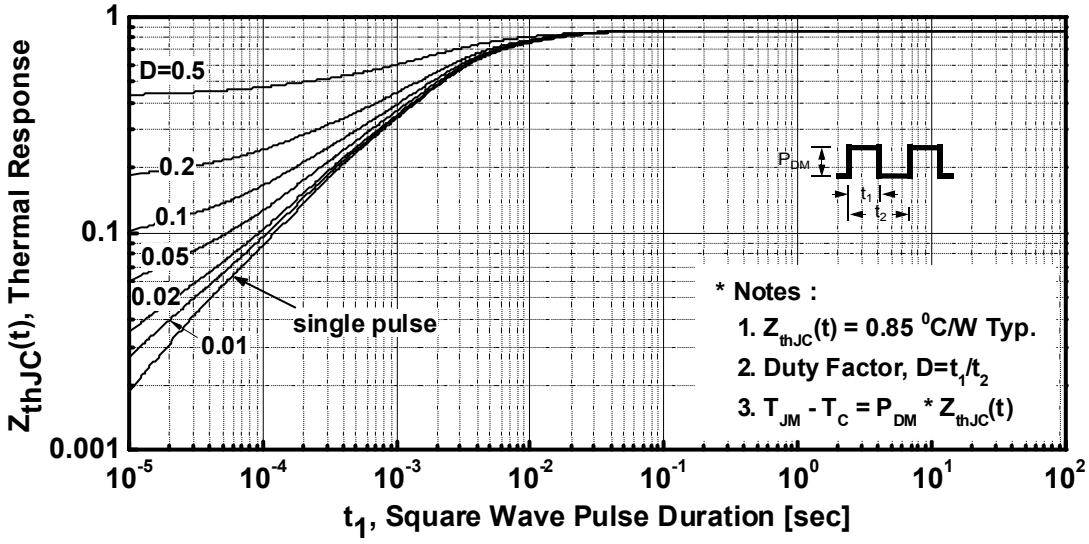
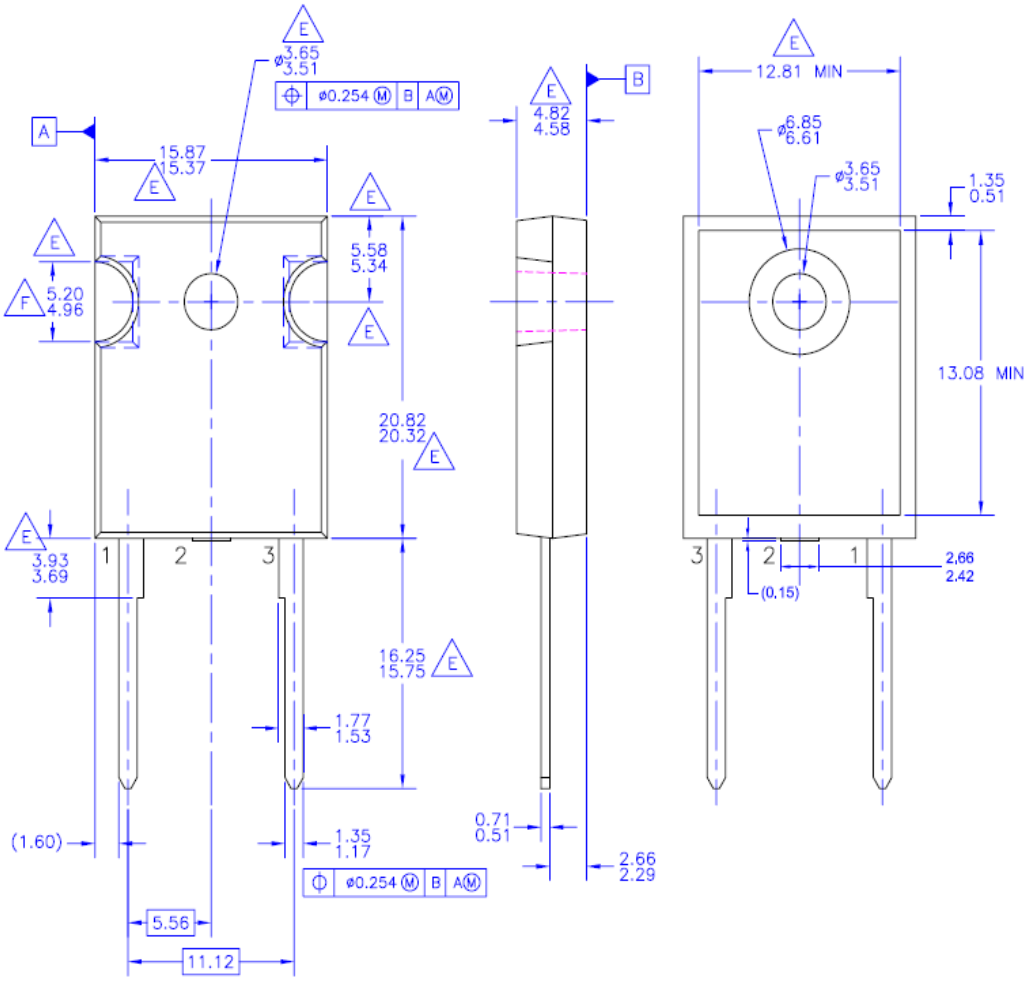


Figure 8. Transient Thermal Response Curve



Mechanical Dimensions

TO-247-2L



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Dimensions in Millimeters

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